

N-Channel 20 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|-------------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^e | Q _g (Typ.) | | |
| | 0.028 at V _{GS} = 4.5 V | 6 ^a | | | |
| 20 | 20 0.042 at V _{GS} = 2.5 V | | 8.8 nC | | |
| | 0.050 at V _{GS} = 1.8 V | 5.6 | | | |



- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Converters
- Load Switch for Portable Applications

| Parameter | | Symbol | Limit | Unit |
|--|------------------------|-----------------------------------|----------------------|------|
| Drain-Source Voltage | | V _{DS} | 20 | V |
| Gate-Source Voltage | | V _{GS} | ± 12 | V |
| | T _C = 25 °C | | 6 ^a | |
| Continuous Droin Current (T 150 °C) | T _C = 70 °C | | 5.1 | |
| Continuous Drain Current ($T_J = 150 \ ^{\circ}C$) | T _A = 25 °C | I _D | 5 ^{b, c} | |
| | T _A = 70 °C | | 4 ^{b, c} | A |
| Pulsed Drain Current | | I _{DM} | 20 | |
| Quality of the Design Divide Quality | T _C = 25 °C | | 1.75 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 1.04 ^{b, c} | |
| | T _C = 25 °C | | 2.1 | |
| Movimum Dower Dissinction | T _C = 70 °C | | 1.3 | w |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 1.25 ^{b, c} | VV |
| | T _A = 70 °C | | 0.8 ^{b, c} | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C |
| Soldering Recommendations (Peak Temperature) | | | 260 | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^{b, d} | t ≤ 5 s | R _{thJA} | 80 | 100 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 40 | 60 | 0/11 |

Notes:

a. Package limited

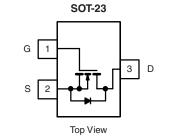
b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 °C/W.

e. Based on T_C = 25 °C.

FREE



| $\begin{array}{ $ |
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| $ \begin{array}{c c c c c c c } \hline Drain-Source Breakdown Voltage & V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 20 & & V \\ V_{DS} Temperature Coefficient & \Delta V_{DS} (T_J) & & I_D = 250 \ \mu A & -2.6 & & mV^{\circ}C \\ \hline & -2.6 & & mV^{\circ}C \\ \hline & -2.6 & & & mV^{\circ}C \\ \hline & -2.6 & & & mV^{\circ}C \\ \hline & -2.6 & & & & mV^{\circ}C \\ \hline & -2.6 & & & & & mV^{\circ}C \\ \hline & Gate-Source Threshold Voltage & V_{GS}(h) & V_{DS} = V_{GS} \ J_D = 250 \ \mu A & 0.45 & & 1.0 & V \\ \hline & Gate-Source Leakage & I_{GSS} & V_{DS} = 0 V, V_{GS} = 4 8 V & & \pm 100 & nA \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V & V_{GS} = 0 V & & & 1 \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V & V_{GS} = 0 V & & & 1 \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V & V_{GS} = 0 V & & & 1 \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V & V_{GS} = 0 V & & & 1 \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V & V_{TJ} = 70 \ \circ C & & & 10 \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V & V_{TJ} = 70 \ \circ C & & & 10 \\ \hline & V_{DS} = 20 \ V, V_{GS} = 0 V \ V_{GS} = 4.5 \ V & & & & & & & & & & & & & & & & & &$ |
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| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ |
| $ \begin{array}{c c c c c c } V_{GS(th)} \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$ |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ |
| $ \begin{array}{c c c c c c c c c c } \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ U_{GS} = 0 \ V, $ |
| $ \begin{array}{c c c c c c c c c c } \hline Zero Gate Voltage Drain Current & I_{DS} & V_{DS} = 20 V, V_{GS} = 0 V, T_J = 70 \ ^{\circ}C & I & I0 & I0 \\ \hline V_{DS} = 20 V, V_{GS} = 0 V, T_J = 70 \ ^{\circ}C & 20 & I & I0 & A \\ \hline Drain-Source On-State Resistance^{a} & P_{DS}(n) & V_{GS} = 4.5 V, I_{D} = 5.0 \ A & 0.028 & I & 0.042 & I & 0 \\ \hline V_{GS} = 1.8 V, I_{D} = 4.7 \ A & 0.042 & I & 0.042 & I & 0 \\ \hline V_{GS} = 1.8 V, I_{D} = 4.3 \ A & 0.050 & I & 0.050 & I & 0 \\ \hline V_{GS} = 1.8 V, I_{D} = 4.3 \ A & 0.050 & I & 0.050 & I & 0 \\ \hline V_{GS} = 1.8 V, I_{D} = 4.3 \ A & 0.050 & I & 0.050 & I & 0 \\ \hline Dynamic^{b} & V_{DS} = 10 \ V, V_{GS} = 10 \ V, I_{D} = 5.0 \ A & 24 & I & S & 0 \\ \hline Dutput Capacitance & C_{ISS} & V_{DS} = 10 \ V, V_{GS} = 0 \ V, f = 1 \ MHz & 105 & I & P \\ \hline Total Gate Charge & Q_{gs} & V_{DS} = 10 \ V, V_{GS} = 5 \ V, I_{D} = 5.0 \ A & 12 & 18 & 0 \\ \hline Gate-Source Charge & Q_{gs} & V_{DS} = 10 \ V, V_{GS} = 5 \ V, I_{D} = 5.0 \ A & 11 & I & 0 \\ \hline Gate Resistance & R_{g} & f = 1 \ MHz & 0.5 & 2.4 & 4.8 & \Omega \\ \hline Turn-On Delay Time & I_{d(on)} & V_{DD} = 10 \ V, R_{L} = 2.2 \ \Omega & V_{CS} = 10 \ V, R_{L} = 2.2 \ \Omega & 17 & 26 \\ \hline \end{array}$ |
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| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ |
| $ \begin{array}{c c c c c c c c c } \hline Dynamic^b & & & & & & & & & & & & & & & & & & &$ |
| $ \begin{array}{c c c c c c c } \hline \mbox{Input Capacitance} & C_{iss} & & & & & & & & & & & & & & & & & & $ |
| $ \begin{array}{c c c c c c c c c } \hline Output Capacitance & C_{oss} & V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz} & 105 & pF \\ \hline Reverse Transfer Capacitance & C_{rss} & & & & & & & & & & & & & & & & & & $ |
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| Turn-On Delay Time $t_{d(on)}$ $V_{DD} = 10 \text{ V}, \text{ R}_L = 2.2 \Omega$ 816Rise Time t_r $V_{DD} = 10 \text{ V}, \text{ R}_L = 2.2 \Omega$ 1726 |
| Rise Time t_r $V_{DD} = 10 V, R_L = 2.2 \Omega$ 1726 $h \approx 4.0 V_{COU} = 4.5 V, R_c = 1.0$ |
| |
| Turn-Off Delay Time $t_{d(off)}$ $I_D \cong 4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ 3147 |
| |
| Fall Time t _f 8 16 ns |
| Turn-On Delay Time t _{d(on)} 5 10 |
| Rise Time t_r $V_{DD} = 10 \text{ V}, \text{ R}_L = 2.2 \Omega$ 13 20 |
| Turn-Off Delay Time $t_{d(off)}$ $I_D \cong 4 \text{ A}, V_{GEN} = 5 \text{ V}, R_g = 1 \Omega$ 2132 |
| Fall Timetf612 |
| Drain-Source Body Diode Characteristics |
| Continuous Source-Drain Diode CurrentIs $T_C = 25 ^{\circ}C$ 1.75A |
| Pulse Diode Forward Current I _{SM} 20 |
| Body Diode Voltage V_{SD} $I_S = 4 \text{ A}, V_{GS} = 0 \text{ V}$ 0.75 1.2 V |
| Body Diode Reverse Recovery Timetrr1220ns |
| Body Diode Reverse Recovery Charge Q_{rr} $I_F = 4 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}, T_I = 25 ^{\circ}\text{C}$ 5 10 nC |
| Reverse Recovery Fall Time t _a |
| Reverse Recovery Rise Time t _b 5 |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

<u>Bse</u>mi

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- 55 °C

1.5

20

T_C =

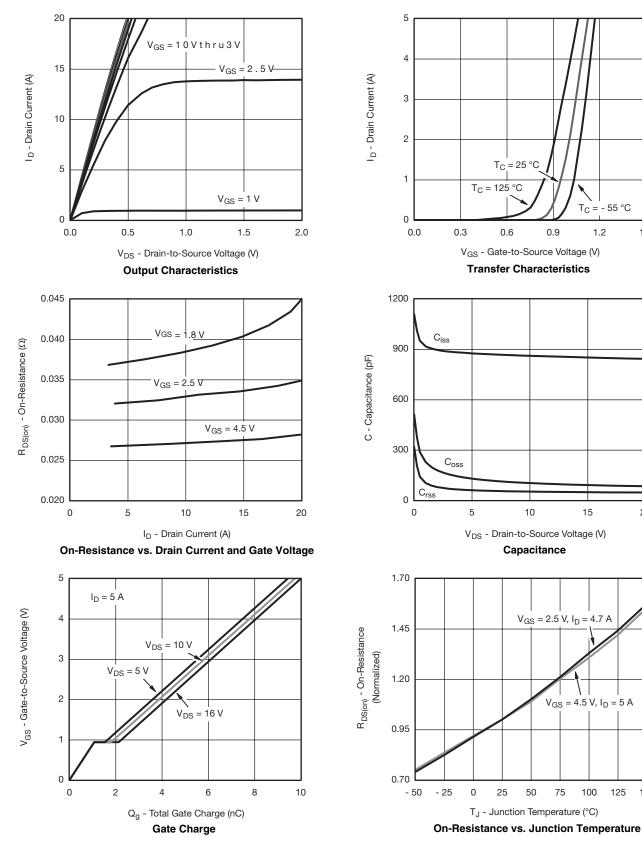
15

100

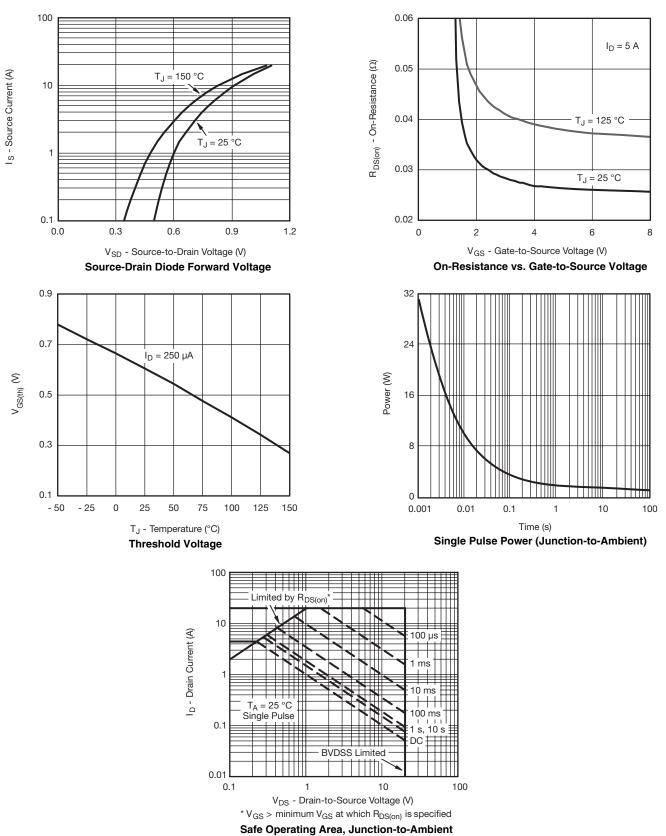
125 150

1.2

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



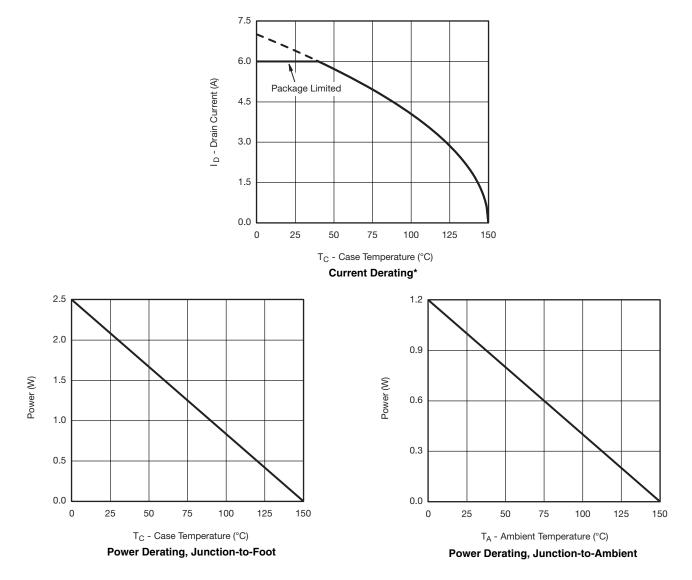




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



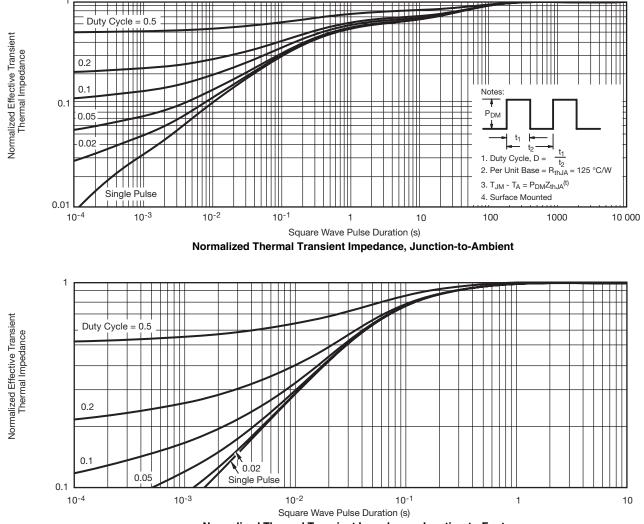
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



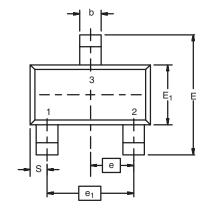
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

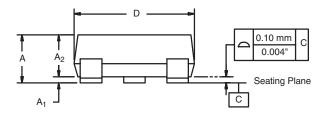


Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD







| Dim | MILLIMETERS | | INCHES | | |
|---------------------------------------|-------------|------|------------|-------|--|
| | Min | Мах | Min | Мах | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | |
| C | 0.085 | 0.18 | 0.003 | 0.007 | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | |
| е | 0.95 BSC | | 0.0374 Ref | | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | |
| L ₁ | 0.64 Ref | | 0.025 Ref | | |
| S | 0.50 Ref | | 0.020 Ref | | |
| q | 3° | 8° | 3° | 8° | |
| ECN: S-03946-Rev. K, 09- DWG: 5479 | Jul-01 | | | | |



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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